



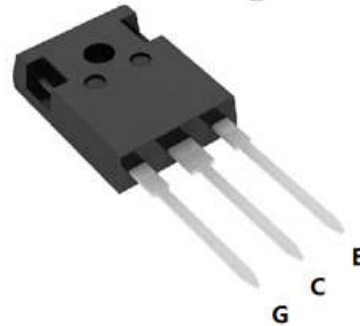
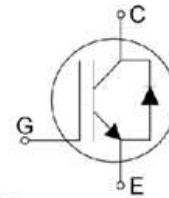
SPT25N120U1

1200V /25A Trench Field Stop IGBT

FEATURES

- High breakdown voltage to 1200V for improved reliability
- Trench-Stop Technology offering :
 - High speed switching
 - High ruggedness, temperature stable
 - Short circuit withstand time – 10μs
 - Low V_{CEsat}
 - Easy parallel switching capability due to positive temperature coefficient in V_{CEsat}
- Enhanced avalanche capability

V_{CE}	1200	V
I_C	25	A
$V_{CE(SAT)} I_C=25A$	2.05	V



APPLICATION

- Uninterruptible Power Supplies
- Solar inverter
- Welding
- PFC applications

Product	Package	Packaging
SPT25N120U1	TO247	Tube



Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	1200	V
DC collector current, limited by T_{jmax} $T_C = 25^\circ C$ $T_C = 100^\circ C$	I_C	50 25	A
Diode Forward current, limited by T_{jmax} $T_C = 25^\circ C$ $T_C = 100^\circ C$	I_F	50 25	A
Continuous Gate-emitter voltage	V_{GE}	± 20	V
Transient Gate-emitter voltage	V_{GE}	± 30	V
Turn off safe operating area $V_{CE} \leq 1200V$, $T_j \leq 150^\circ C$	-	75	A
Pulsed collector current, $V_{GE} = 15V$, t_p limited by T_{jmax}	I_{CM}	75	A
Short Circuit Withstand Time, $V_{GE} = 15V$, $V_{CE} \leq 600V$	T_{sc}	10	μs
Power dissipation, $T_j = 25^\circ C$	P_{tot}	210	W
Operating junction temperature	T_j	-40...+150	$^\circ C$
Storage temperature	T_s	-55...+150	$^\circ C$
Soldering temperature, wave soldering 1.6mm (0.063in.) from case for 10s	-	260	$^\circ C$

Thermal Resistance

Parameter	Symbol	Max. Value	Unit
IGBT thermal resistance, junction - case	$R_{\theta(j-c)}$	0.61	K/W
Diode thermal resistance, junction - case	$R_{\theta(j-c)}$	1.2	K/W



Thermal resistance, junction - ambient	$R_{\theta(j-a)}$	40	K/W
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Electrical Characteristics of the IGBT ($T_j = 25^\circ\text{C}$ unless otherwise specified) :

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Static						
Collector-Emitter breakdown voltage	BV_{CES}	$V_{GE}=0V, I_C=250\mu A$	1200	-	-	V
Gate threshold voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=250\mu A$	5.4	6.0	6.6	V
Collector-Emitter Saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=25A$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	- -	2.05 2.65	2.45 -	V
Zero gate voltage collector current	I_{CES}	$V_{CE} = 1200V, V_{GE} = 0V$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	- -	- -	100 1000	μA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0V, V_{GE} = \pm 20V$	-	-	100	nA
Transconductance	g_{fs}	$V_{CE}=20V, I_C=25A$	-	13	-	S

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Dynamic						
Input capacitance	C_{ies}	$V_{CE} = 25V, V_{GE} = 0V,$ $f = 1\text{MHz}$	-	1865	-	pF
Output capacitance	C_{oes}		-	70	-	
Reverse transfer capacitance	C_{res}		-	45	-	
Gate charge	Q_G	$V_{CC} = 960V, I_C = 25A,$ $V_{GE} = 15V$	-	137	-	nC
Short circuit collector current	$I_{C(SC)}$	$V_{GE}=15V, t_{SC} \leq 10\mu s$ $V_{CC}=600V,$ $T_{j, start}=25^\circ\text{C}$	-	140	-	A



Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Dynamic , at T_j = 25° C						
Turn-on delay time	t _{d(on)}	V _{CC} = 600V, I _C = 25A, V _{GE} = 0/15V, R _g =42Ω	-	62	-	ns
Rise time	t _r		-	22	-	ns
Turn-on energy	E _{on}		-	3.3	-	mJ
Turn-off delay time	t _{d(off)}		-	297	-	ns
Fall time	t _f		-	94	-	ns
Turn-off energy	E _{off}		-	0.65	-	mJ

Electrical Characteristics of the DIODE

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic , at T_j = 25° C						
Diode Forward Voltage	V _{FM}	I _F = 25A	-	3.1	-	V
Reverse Recovery Time	T _{rr}	I _F = 25A, di/dt= 600A/μs	-	420	-	nS
Reverse Recovery Current	I _{rr}		-	17	-	A
Reverse Recovery Charge	Q _{rr}		-	2570	-	nC



Fig. 1 FBSOA characteristics

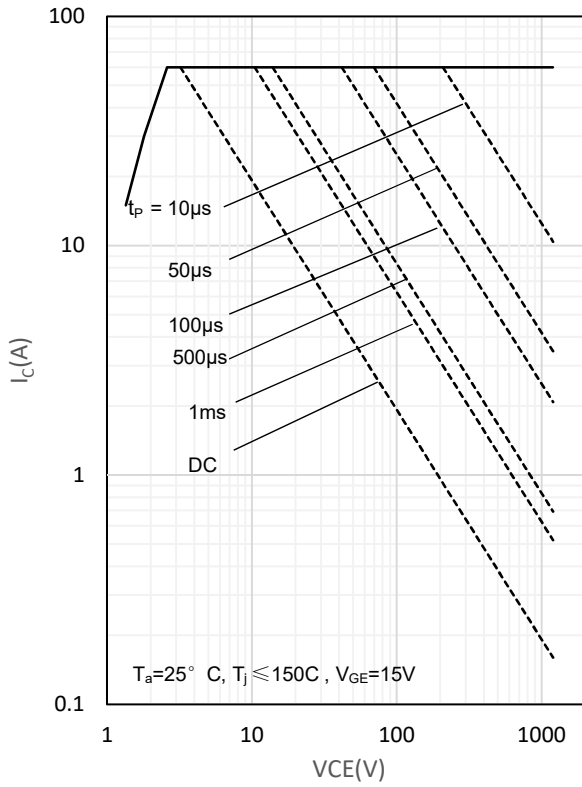


Fig. 2 Load Current vs. Frequency

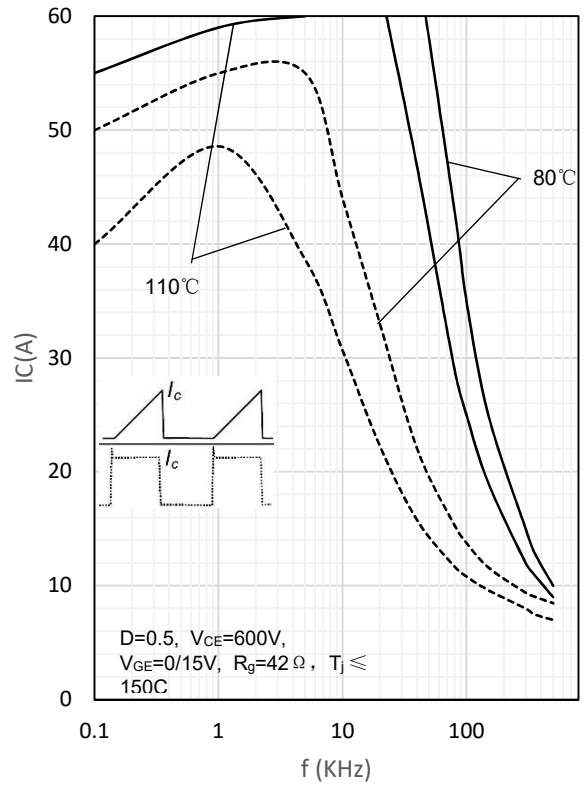


Fig. 3 Output characteristics

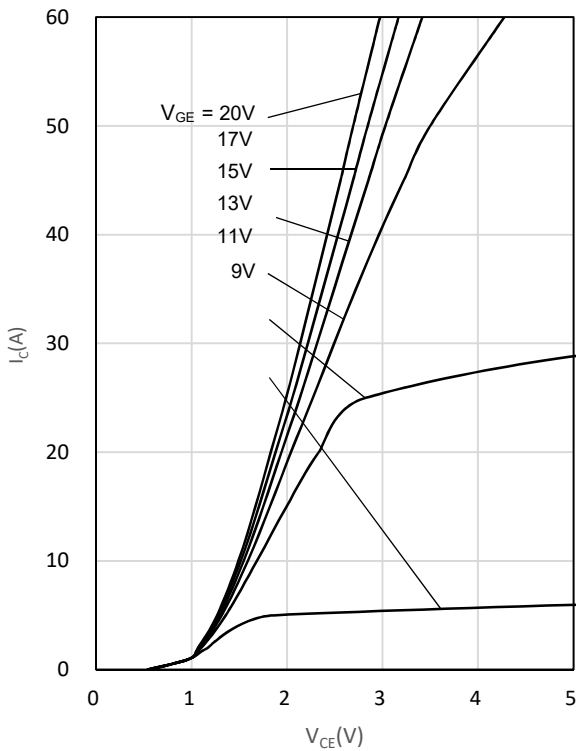


Fig. 4 Saturation voltage characteristics

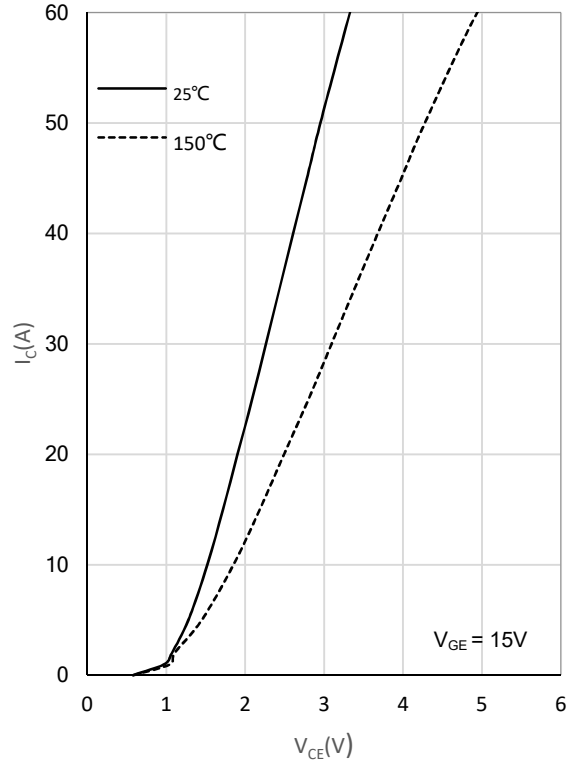




Fig. 5 Switching times vs. gate resistor

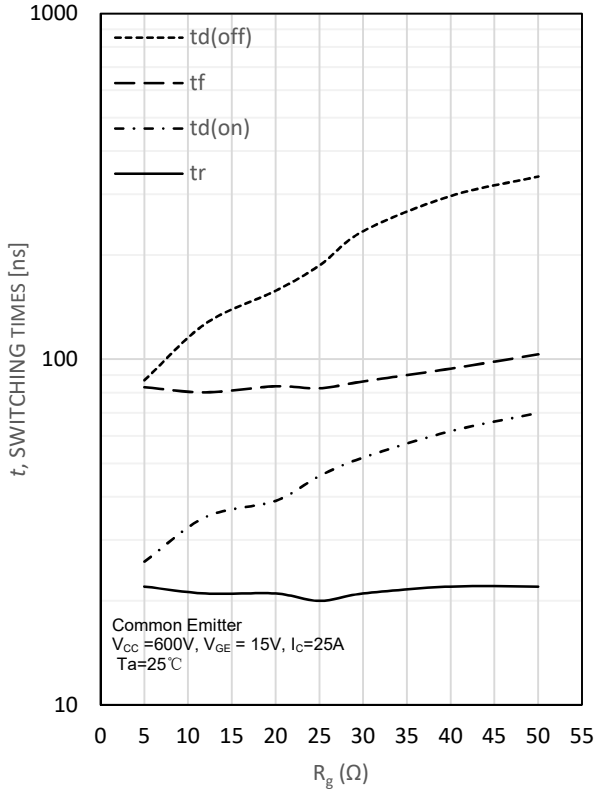


Fig. 6 Switching times vs. collector current

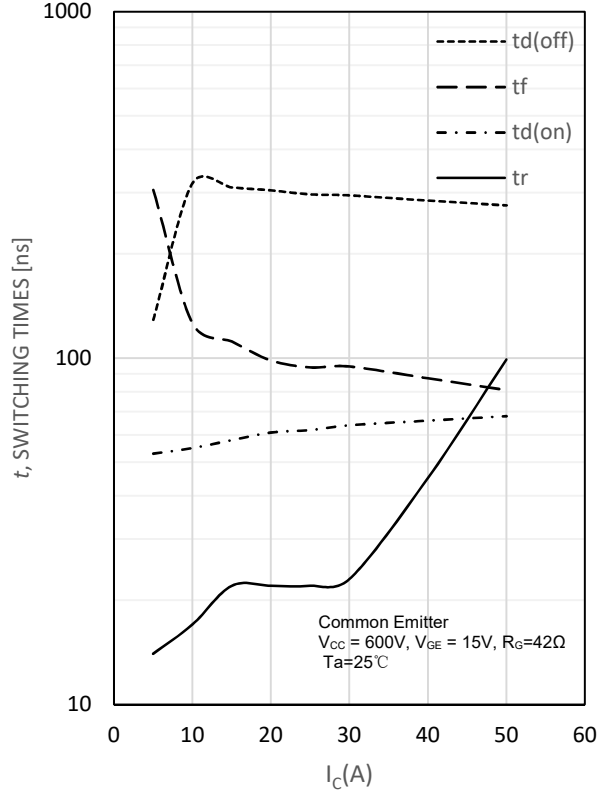


Fig. 7 Switching loss vs. gate resistor

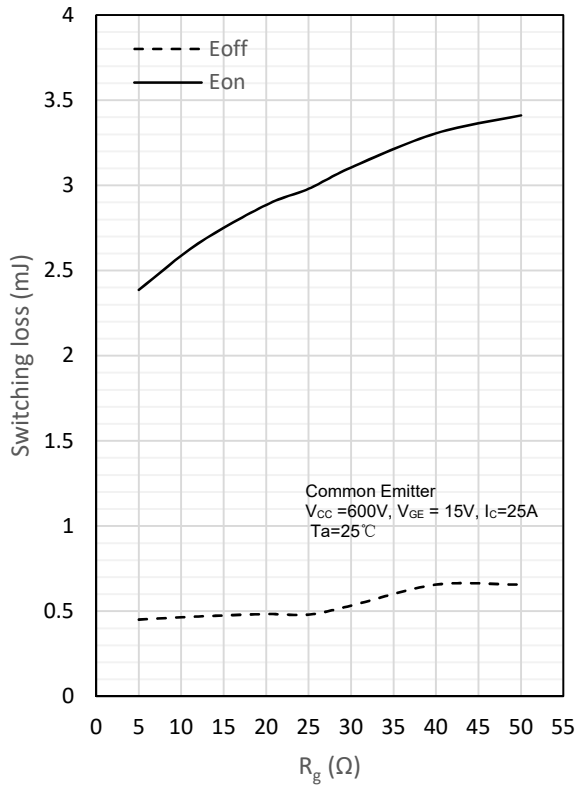


Fig. 8 Switching loss vs. collector current

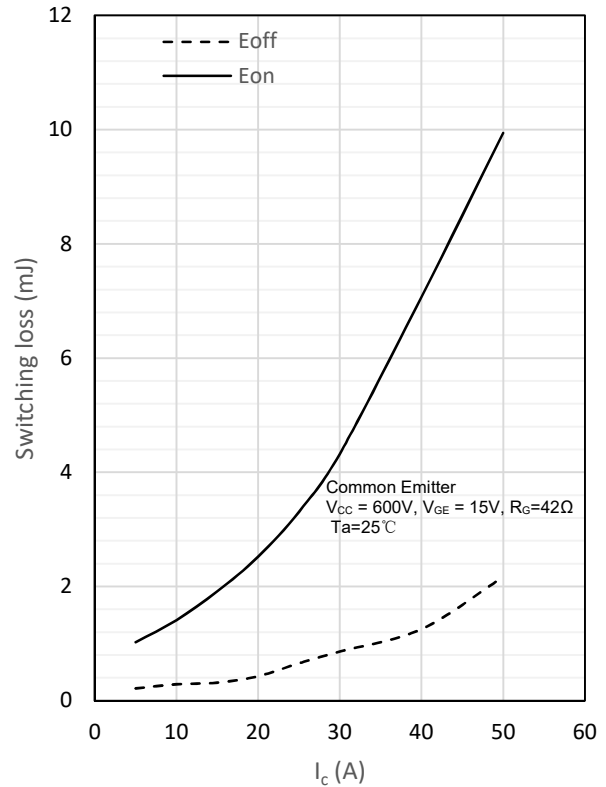




Fig. 9 Gate charge characteristics

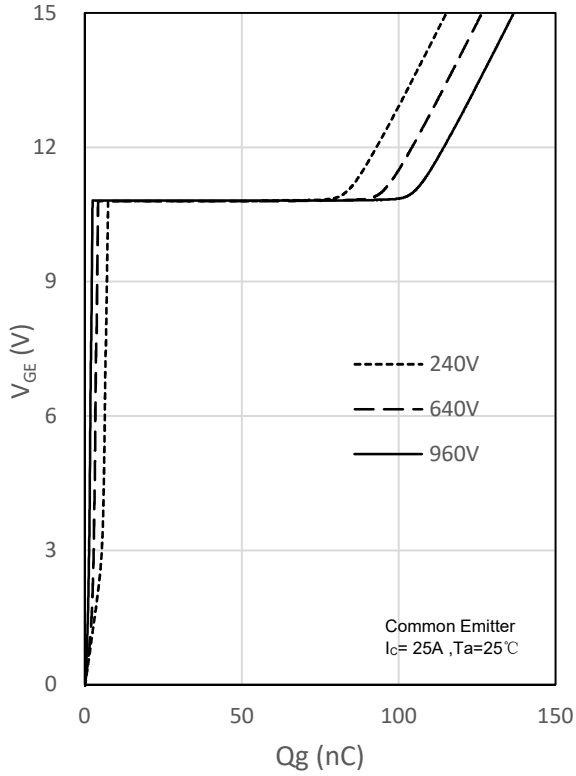
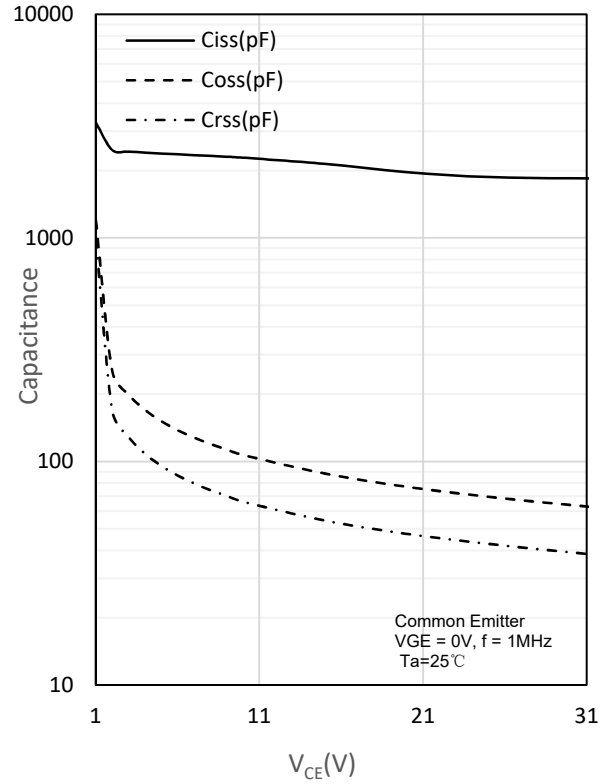
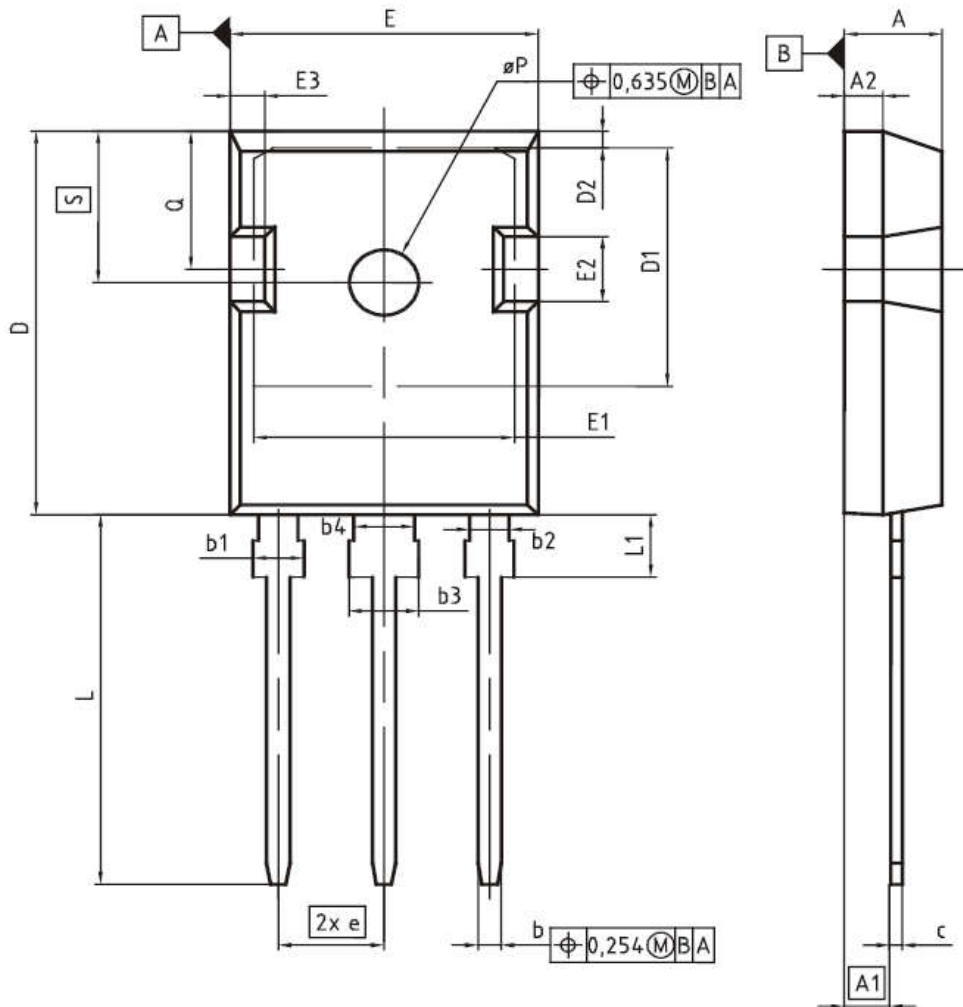


Fig. 10 Capacitance characteristics





PG-TO247-3



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.27	2.54	0.089	0.100
A2	1.85	2.16	0.073	0.085
b	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
c	0.55	0.68	0.022	0.027
D	20.80	21.10	0.819	0.831
D1	16.25	17.65	0.640	0.695
D2	0.95	1.35	0.037	0.053
E	15.70	16.13	0.618	0.635
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.00	2.60	0.039	0.102
e	5.44 (BSC)		0.214 (BSC)	
N	3		3	
L	19.80	20.32	0.780	0.800
L1	4.10	4.47	0.161	0.176
ϕP	3.50	3.70	0.138	0.146
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248